

146783-3 ✓ ACTIVE

AMPMODU | Modu Connector System

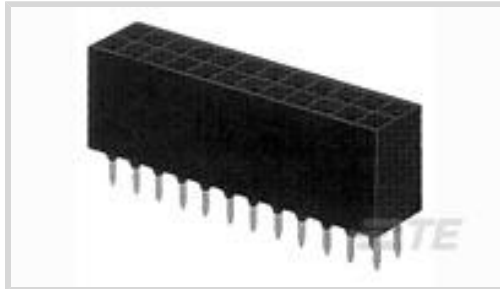
TE Internal #: 146783-3

PCB Mount Receptacle, Vertical, Board-to-Board, 30 Position, 2.54 mm [.1 in] Centerline, Gold, Through Hole - Solder, Signal, Modu Connector System

[View on TE.com >](#)



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: **PCB Mount Receptacle**

PCB Mount Orientation: **Vertical**

Connector System: **Board-to-Board**

Number of Positions: **30**

Number of Rows: **2**

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Stackable	No
PCB Mount Orientation	Vertical
Number of Positions	30
Number of Rows	2
Board-to-Board Configuration	Parallel

Body Features

Connector Profile	Standard
Primary Product Color	Black

Contact Features

Contact Protection Type	Closed Entry Housing
Mating Square Post Dimension	.64 mm[.025 in]
	300 – 1500 μ m
PCB Contact Termination Area Plating Material Finish	Bright



Contact Shape & Form	Short Point
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Type	Socket
Contact Current Rating (Max)	2 A

Termination Features

Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Rectangular Termination Post & Tail Width	.69 mm[.027 in]
Termination Post & Tail Length	3.68 mm[.145 in]
Termination Method to Printed Circuit Board	Through Hole - Solder

Mechanical Attachment

PCB Mount Retention Type	Retention Solder Tails
Mating Alignment	Without
PCB Mount Retention	With
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount

Housing Features

Mating Entry Location	Top
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Polyester - GF

Dimensions

Connector Height	8.64 mm[.34 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Stack Height	12.52 mm[.493 in]
PCB Thickness (Recommended)	1.57 mm[.062 in]

Usage Conditions

Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]

Operation/Application

Solder Process Feature	Board Standoff
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Circuit Application

Signal

Industry Standards

UL Flammability Rating

UL 94V-0

Packaging Features

Packaging Quantity

15

Packaging Type

Tube

Product Compliance

For compliance documentation, visit the product page on [TE.com](#)>

EU RoHS Directive 2011/65/EU

Not Compliant

EU ELV Directive 2000/53/EC

Compliant with Exemptions

China RoHS 2 Directive MIIT Order No 32, 2016

Restricted Materials Above Threshold

EU REACH Regulation (EC) No. 1907/2006

Current ECHA Candidate List: JUNE 2023
(235)Candidate List Declared Against: JUNE
2023 (235)

SVHC > Threshold:

Pb (13% in Component Part)

Article Safe Usage Statements:

Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Halogen Content

Not Low Halogen - contains Br or Cl > 900
ppm.

Solder Process Capability

Wave solder capable to 240°C

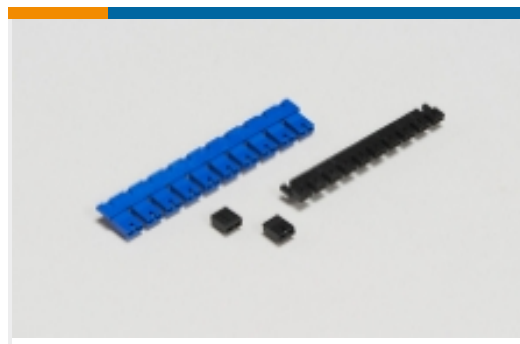
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Also in the Series | [Modu Connector System](#)



Automotive Housings(1)



Board-to-Board Jumpers & Shunts(5)



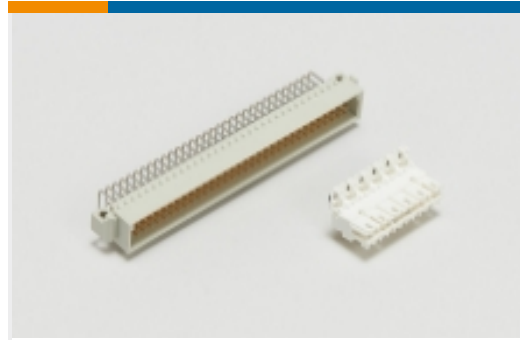
Connector Caps & Covers(4)



Connector Hardware(4)

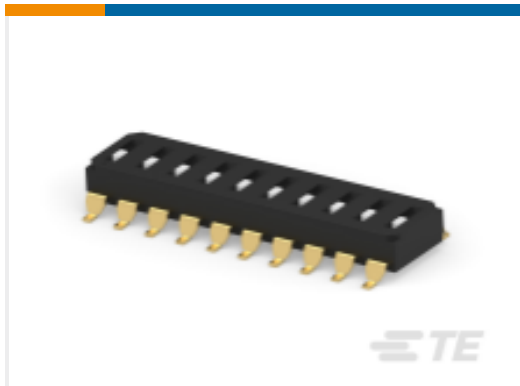


PCB Headers & Receptacles(1244)



Standard Edge Connectors(2)

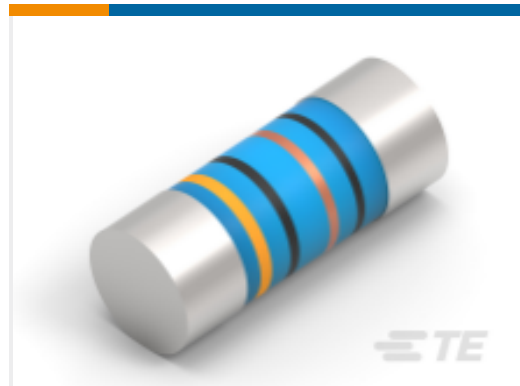
Customers Also Bought



TE Part #3-2319848-1
END STACK DIP 10P G RECESS SEAL TUBE



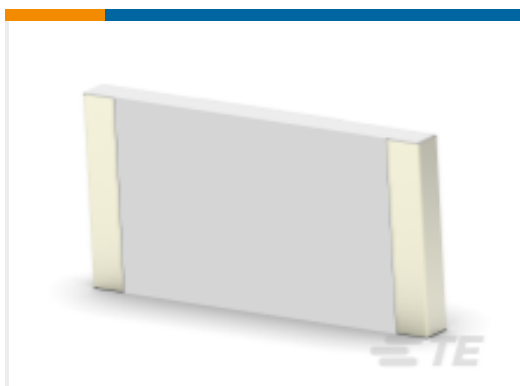
TE Part #4-2176391-7
RQ 1206 37K4 0.1% 10PPM 5K RL



TE Part #2176314-4
MELF SMA_A 180R 0.1% 15PPM 0102 0.3W



TE Part #1-928836-2
MOD2 PIN WITH A-PIN L/P



TE Part #7-2176246-6
CRGS2512 5% 1M8



TE Part #3-1415020-1
PT570N20



TE Part #1-1437581-1
ASE22RL=AUTOSLIDE DP

Documents

Product Drawings

30 MODII VRT DR CE W/HLDWN

English

Product Specifications

Application Specification

English